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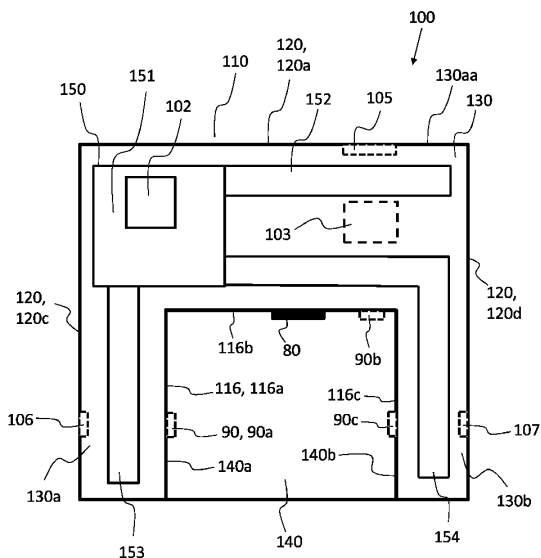


FIG. 1

(57) Abstract: There may be provided a portable electronic de-  
vice which may include a housing partitioned into a component  
enclosure portion and a module bay portion. The portable elec-  
tronic device may include a heat-generating component and a  
heat-dissipation arrangement disposed within the component en-  
closure portion of the housing. The heat-dissipation arrangement  
may include a thermal transfer body in thermal contact with the  
heat-generating component, a primary thermal conveyance duct,  
and an auxiliary thermal conveyance duct.

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